IGBT - Field Stop

600 V, 75 A

FGH75N60UF

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 V (Typ.) @ I_C = 75 A$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

Applications

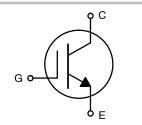
• Solar Inverters, UPS, Welder, PFC

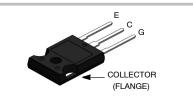


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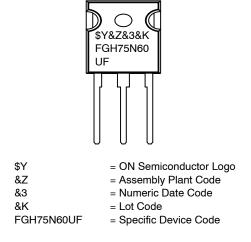
V _{CES}	Ι _C
600 V	75 A





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate to Emitter Voltage Transient Gate-to-Emitter Voltage		±20	V
			±30	V
Ι _C	Collector Current T _C	_C = 25°C	150	А
	Tc	_C = 100°C	75	А
I _{CM} (Note 1)	Pulsed Collector Current T _C	_C = 25°C	225	А
PD	Maximum Power Dissipation T _C	_C = 25°C	452	W
	Тс	c = 100°C	181	W
TJ	Operating Junction Temperature		–55 to +150	°C
T _{STG}	Storage Temperature Range		–55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol Parameter		Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.276	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75N60UFTU	FGH75N60UF	TO-247	Tube	N/A	N/A	30ea

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
FF CHARAC	TERISTICS	-	-	-	-	-
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I _C = 250 μ A	-	0.75	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	_	-	250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	ERISTICS					-
V _{GE(th)}	G-E Threshold Voltage	I_C = 250 μ A, V_{CE} = V_{GE}	4.0	5.0	6.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 75 A, V _{GE} = 15 V,	-	1.9	2.4	V
		I _C = 75 A, V _{GE} = 15 V, T _C = 125°C	-	2.15	-	v
	ARACTERISTICS					
C _{ies}	Input Capacitance	$V_{CE} = 30 \text{ V}, \text{ V}_{GE} = 0 \text{ V},$	-	3850	-	pF
Coes	Output Capacitance	f = 1 MHz	_	375	-	pF
C _{res}	Reverse Transfer Capacitance	1	_	147	-	pF
WITCHING C	HARACTERISTICS					
T _{d(on)}	Turn-On Delay Time	$V_{\rm CC}$ = 400 V, I _C = 75 A,	-	27	-	ns
T _r	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	70	-	ns
T _{d(off)}	Turn–Off Delay Time		-	128	-	ns
T _f	Fall Time		-	30	80	ns
Eon	Turn-On Switching Loss		-	3.05	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.35	-	mJ
E _{ts}	Total Switching Loss		-	4.4	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A},$	-	27	-	ns
T _r	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	_	74	-	ns
T _{d(off)}	Turn-Off Delay Time	1	-	153	-	ns
Τ _f	Fall Time		-	35	-	ns
Eon	Turn-On Switching Loss		-	3.6	-	mJ
E _{off}	Turn-Off Switching Loss	-	-	1.08	-	mJ
E _{ts}	Total Switching Loss		-	5.4	-	mJ
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 75 A, V _{GE} = 15 V	-	250	-	nC
Q _{ge}	Gate to Emitter Charge		-	30	-	nC
Q _{gc}	Gate to Collector Charge		_	130	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

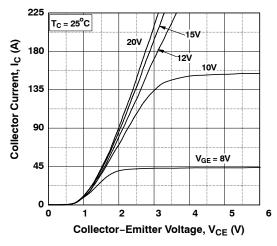


Figure 1. Typical Output Characteristics

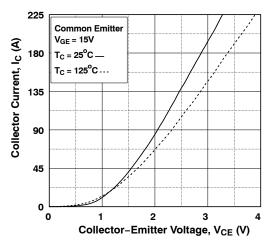


Figure 3. Typical Saturation Voltage Characteristics

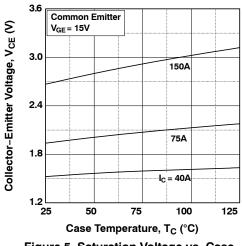


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

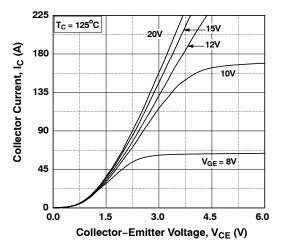


Figure 2. Typical Output Characteristics

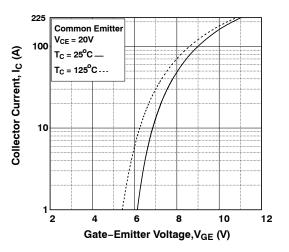


Figure 4. Transfer Characteristics

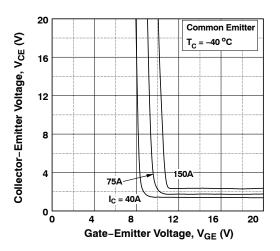


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

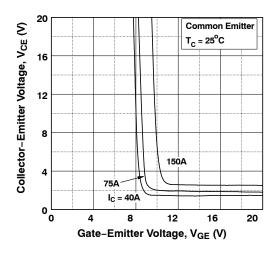


Figure 7. Saturation Voltage vs. V_{GE}

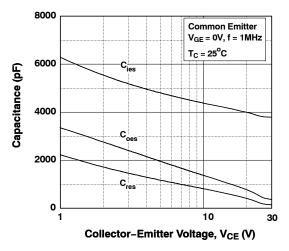


Figure 9. Capacitance Characteristics

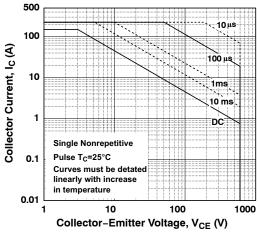


Figure 11. SOA Characteristics

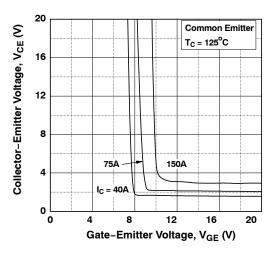


Figure 8. Saturation Voltage vs. V_{GE}

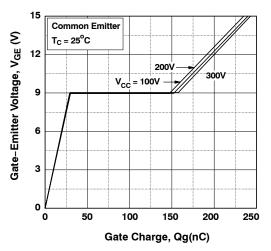
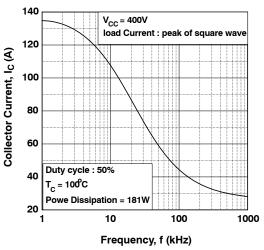
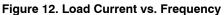
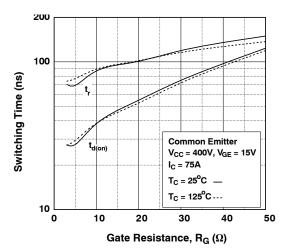


Figure 10. Gate Charge Characteristics

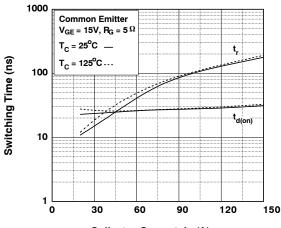




TYPICAL PERFORMANCE CHARACTERISTICS (Continued)







Collector Current, I_C (A)

Figure 15. Turn-on Characteristics vs. Collector Current

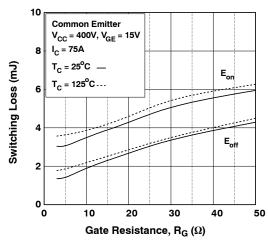


Figure 17. Switching Loss vs. Gate Resistance

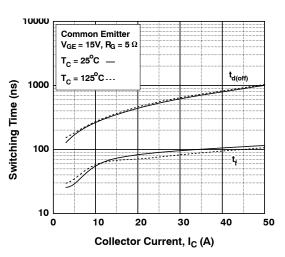


Figure 14. Turn-off Characteristics vs. Gate Resistance

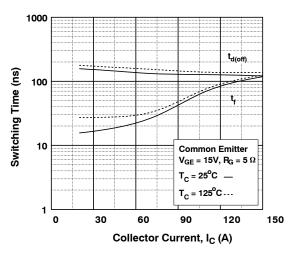


Figure 16. Turn-off Characteristics vs. Collector Current

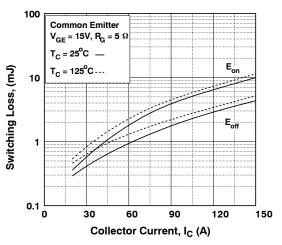


Figure 18. Switching Loss vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

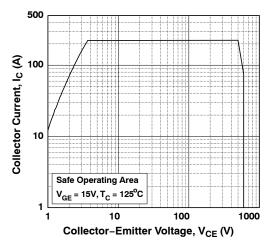


Figure 19. Turn off Switching SOA Characteristics

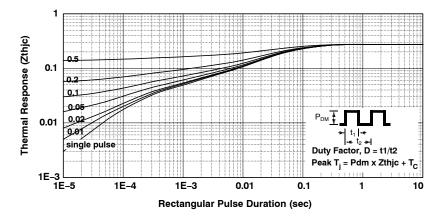


Figure 20. Transient Thermal Impedance of IGBT





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